



## Bias Resistor Transistors

PNP Silicon Surface Mount Transistors with Monolithic

Bias Resistor Network

### FEATURES

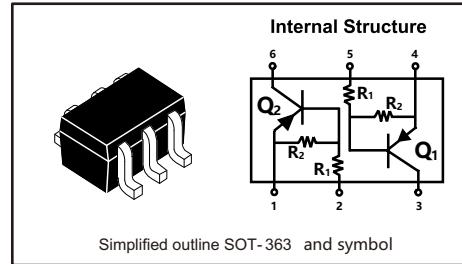
- Reduces board space
- Simplifies Circuit Design
- Reduces Board Space and Component Count

### Mechanical Data

- Case: SOT-363
- $R_1 = 2.2\text{K}\Omega$  (Typ),  $R_2 = 47\text{K}\Omega$  (Typ)

### PINNING

PIN	DESCRIPTION
2,5	BASE
1,4	EMITTER
3,6	COLLECTOR



### MAXIMUM RATINGS (Ta = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-50	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-50	V
Output current	I <sub>c</sub>	-100	mA
Power dissipation	P <sub>D</sub>	250	mW
Thermal Resistance – Junction-to-Ambient	R <sub>θJA</sub>	500	°C/W
Junction temperature	T <sub>J</sub>	150	°C
Range of storage temperature	T <sub>stg</sub>	-55~ +150	°C

### ELECTRICAL CHARACTERISTICS(TA = 25°C unless otherwise noted.)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	I <sub>c</sub> = -10uA , I <sub>E</sub> = 0	-50			V
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	I <sub>c</sub> = -2mA , I <sub>B</sub> = 0	-50			V
Emitter-base breakdown voltage	V <sub>(BR)EBO</sub>	I <sub>E</sub> = -1mA , I <sub>c</sub> = 0	-5			V
Collector-Base Cut off Current	I <sub>CBO</sub>	V <sub>CB</sub> = -50V , I <sub>E</sub> = 0			-100	nA
Collector-Emitter Cut off Current	I <sub>CEO</sub>	V <sub>CE</sub> = -50V , I <sub>B</sub> = 0			-0.5	uA
Emitter-Base Cut off Current	I <sub>EBO</sub>	V <sub>EB</sub> = -6V , I <sub>c</sub> = 0			-0.2	mA
DC Current Gain	h <sub>FE</sub>	V <sub>CE</sub> = -10V , I <sub>c</sub> = -5mA	80			
Output Voltage (on)	V <sub>OL</sub>	V <sub>CE</sub> = -5.0V , V <sub>BE</sub> = -2.5V , R <sub>L</sub> = 1.0KΩ			-0.2	V
Output Voltage (off)	V <sub>OH</sub>	V <sub>CE</sub> = -5.0V , V <sub>BE</sub> = -0.5V , R <sub>L</sub> = 1.0KΩ	-4.9			V
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	I <sub>c</sub> = -10mA , I <sub>B</sub> = -0.1mA			-0.25	V
Input Voltage(off)	V <sub>I(off)</sub>	V <sub>CE</sub> = -5V , I <sub>c</sub> = -100μA	-0.5			V
Input Voltage(on)	V <sub>I(on)</sub>	V <sub>CE</sub> = -0.3V , I <sub>c</sub> = -5mA			-1.1	V
Input resistance	R <sub>1</sub>		1.5	2.2	2.9	KΩ
Input resistance	R <sub>2</sub>		32.9	47.0	61.1	KΩ
Resistance ratio	R <sub>2</sub> / R <sub>1</sub>		17.1	21.4	25.6	



### Typical Performance Characteristics

Fig 1. HFE vs. IC

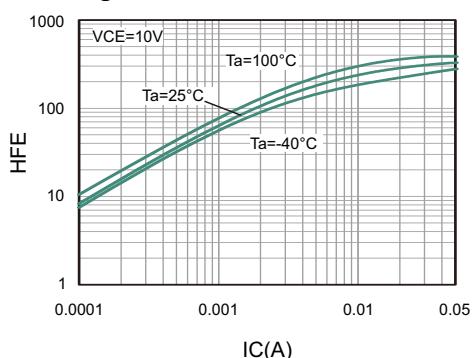


Fig 2. Vin vs. IC

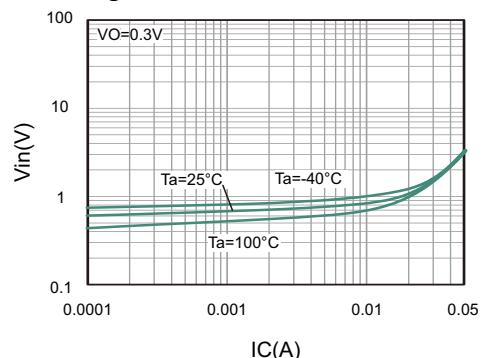


Fig 3. IC vs. Vin

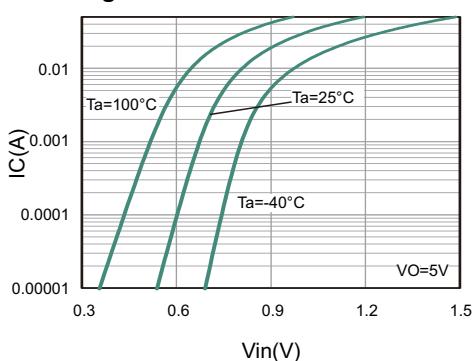


Fig 4. VCE(sat) vs. IC

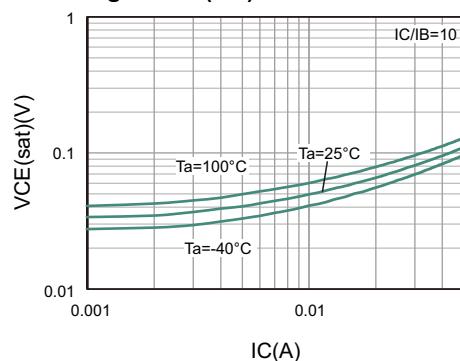
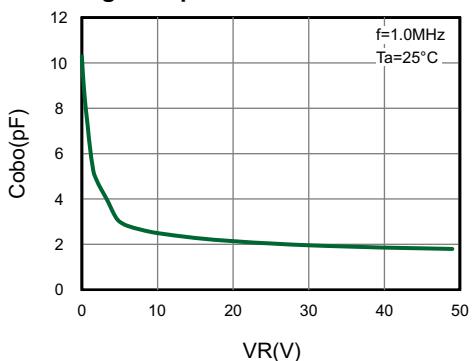
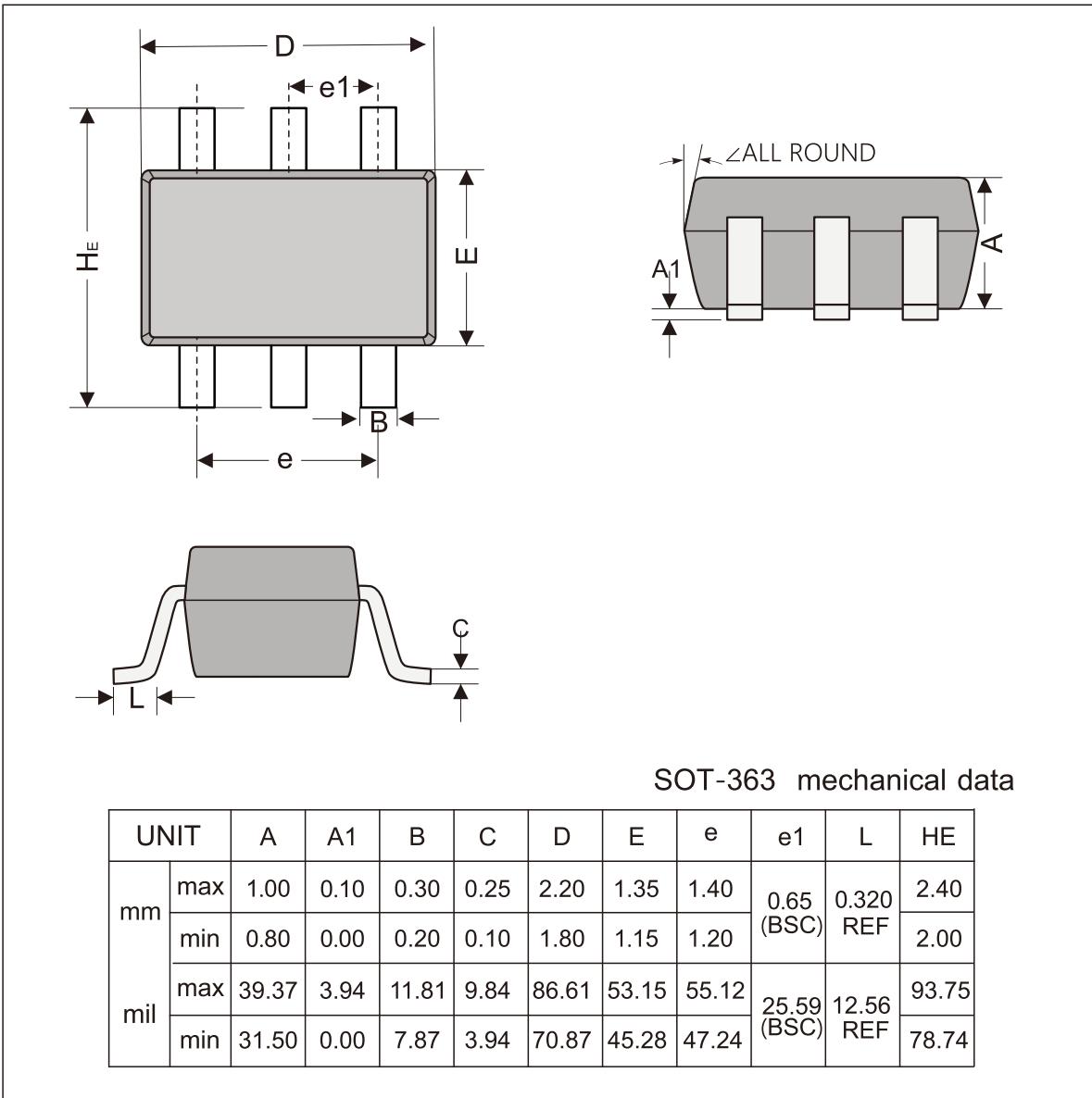


Fig 5. Capacitance





### SOT-363 Package Outline Dimensions



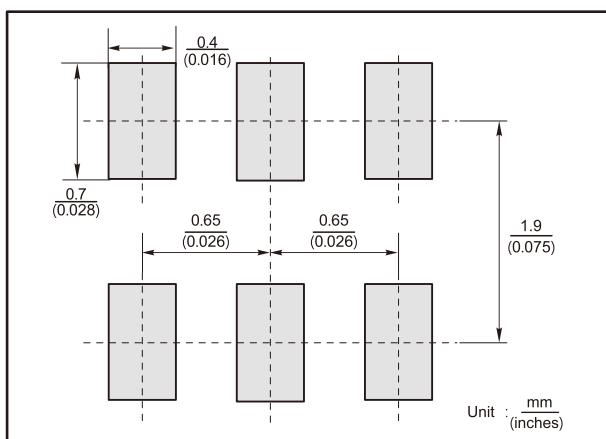
SOT-363 mechanical data

UNIT		A	A1	B	C	D	E	e	e1	L	HE
mm	max	1.00	0.10	0.30	0.25	2.20	1.35	1.40	0.65 (BSC)	0.320 REF	2.40
	min	0.80	0.00	0.20	0.10	1.80	1.15	1.20			2.00
mil	max	39.37	3.94	11.81	9.84	86.61	53.15	55.12	25.59 (BSC)	12.56 REF	93.75
	min	31.50	0.00	7.87	3.94	70.87	45.28	47.24			78.74

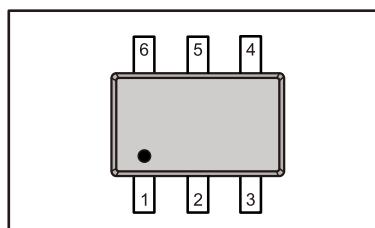
#### The recommended mounting pad size

#### Marking

Type number	Marking code
JDTA223JWH	J23



#### Pin Point





## Important Notice and Disclaimer

Jingdao Microelectronics reserves the right to make changes to this document and its products and specifications at any time without notice.

Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.

Jingdao Microelectronics makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Jingdao Microelectronics assume any liability for application assistance or customer product design.

Jingdao Microelectronics does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application.

No license is granted by implication or otherwise under any intellectual property rights of Jingdao Microelectronics.

Jingdao Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of Jingdao Microelectronics.